

Zalman ZM-STC7 heat sink compound 7.2 W/m·K 4 g

Brand : Zalman
Product code: ZM-STC7
Product name : ZM-STC7

7.2 W/m·K, 220 Pa.s, 4 g
Zalman ZM-STC7. Thermal conductivity: 7.2 W/m·K, Density: 2.6 g/cm³, Constitutive ingredients: Zinc oxide, Silicone. Width: 117.4 mm, Depth: 21.2 mm, Height: 15 mm. Quantity per pack: 1 pc(s), Package type: Polybag with hanging hole



Features		Weight & dimensions	
Thermal conductivity	7.2 W/m·K	Width	117.4 mm
Density	2.6 g/cm ³	Depth	21.2 mm
Constitutive ingredients	Zinc oxide, Silicone	Height	15 mm
Product colour	Grey	Weight	4 g
Viscosity note	220 Pa.s	Packaging data	
Technical details		Quantity per pack *	1 pc(s)
Compliance certificates	RoHS	Package type	Polybag with hanging hole



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